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# SS16-AU

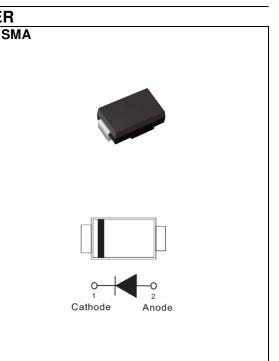


#### Features

- Low forward voltage drop
- Deal for automated placement
- Low power loss, high efficiency
- High surge current capability
- Green molding compound as per IEC 61249 standard
- Lead free in compliance with EU RoHS 2.0
- AEC-Q101 qualified

#### **Mechanical Data**

- Case: JEDEC DO-214AC molded plastic
- Polarity: Color Band denotes cathode end
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 0.0023 ounces, 0.0679 grams



### **Maximum Ratings and Thermal Characteristics** ( $T_A = 25^{\circ}C$ unless otherwise noted)

PARAMETER	SYMBOL	LIMIT	UNITS
Maximum Recurrent Peak Reverse Voltage	V <sub>RRM</sub>	60	V
Maximum RMS Voltage	V <sub>RMS</sub>	42	V
Maximum DC Blocking Voltage	V <sub>DC</sub>	60	V
Maximum Average Forward Rectified Current	$I_{F(AV)}$	1	А
Peak Forward Surge Current 8.3 ms single half sine-wave superimposed on rated load per diode	I <sub>FSM</sub>	30	A
Typical Junction Capacitance Measured at 1 MHz And Applied $V_{B} = 4V$	CJ	50	pF
bical Thermal Resistance per diode $R_{\theta JA}^{(1)}$ $R_{\theta JA}^{(2)}$ $R_{\theta JL}^{(2)}$		150 88 28	°C/W
Operating Junction Temperature Range	TJ	-55 to +150	°C
Storage Temperature Range	T <sub>STG</sub>	-55 to +150	°C



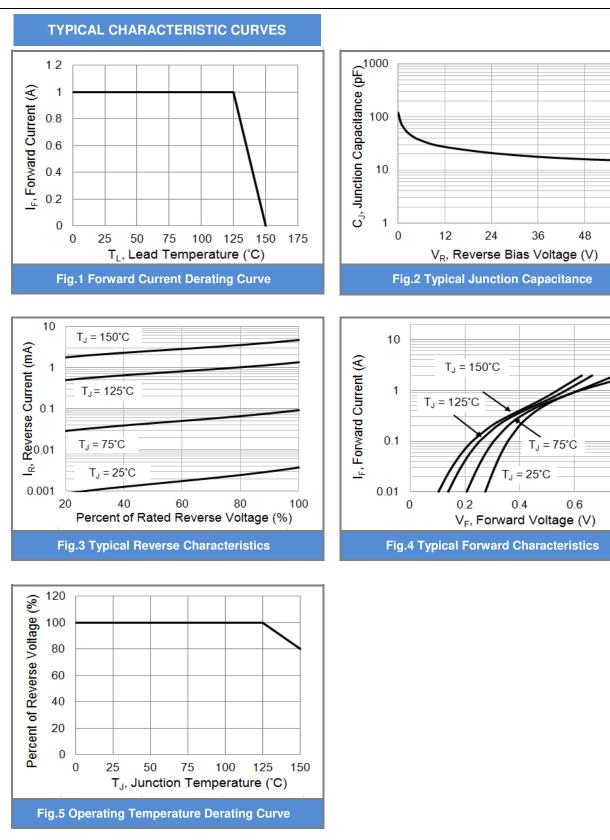
## **Electrical Characteristics** ( $T_A = 25^{\circ}C$ unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Instantaneous forward voltage	V <sub>F</sub>	$I_F = 0.5 \text{ A}, T_J = 25 ^{\circ}\text{C}$	-	0.49	-	V
		$I_F = 1 \text{ A},  \text{T}_J = 25 ^{\circ}\text{C}$	-	-	0.7	
		$I_F = 0.5 \text{ A}, T_J = 125 ^{\circ}\text{C}$	-	0.45	-	
		$I_F = 1 \text{ A},  \text{T}_J = 125 ^{\circ}\text{C}$	-	0.57	-	
Reverse current	I <sub>R</sub> <sup>(3)</sup>	$V_{\rm R} = 48 \text{ V}, \text{ T}_{\rm J} = 25 ^{\circ}\text{C}$	-	2.5	-	uA
		$V_{R} = 60 \text{ V}, \text{ T}_{J} = 25 ^{\circ}\text{C}$	-	-	100	
		$V_{\rm R} = 60 \text{ V}, \text{ T}_{\rm J} = 100 ^{\circ}\text{C}$	-	-	5	mA

NOTES:

- 1. Mounted on a FR4 PCB, single-sided copper, mini pad
- 2. Mounted on a FR4 PCB, single-sided copper, with 100  $\rm cm^2$  copper pad area
- 3. Short duration pulse test used to minimize self-heating effect





60

0.8

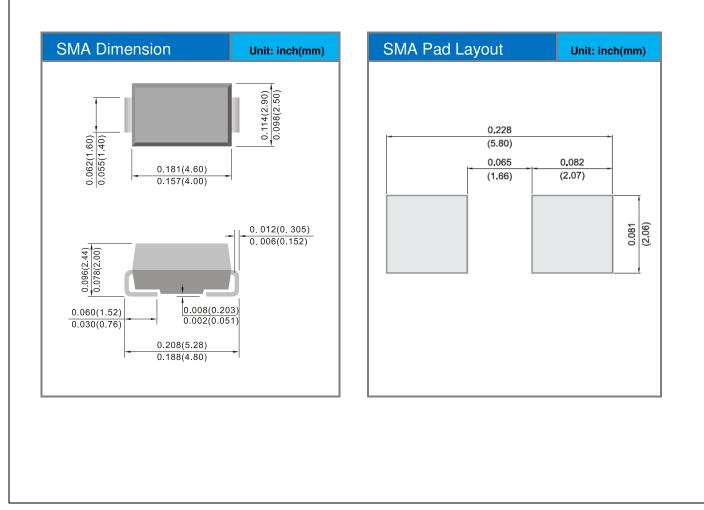




### Part No Packing Code Version

Part No Packing Code	Package Type	Packing Type	Marking	Version
SS16-AU_R2_000A1	SMA	7500 pcs / 13" reel	SS16	Halogen free

### **Packaging Information & Mounting Pad Layout**







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